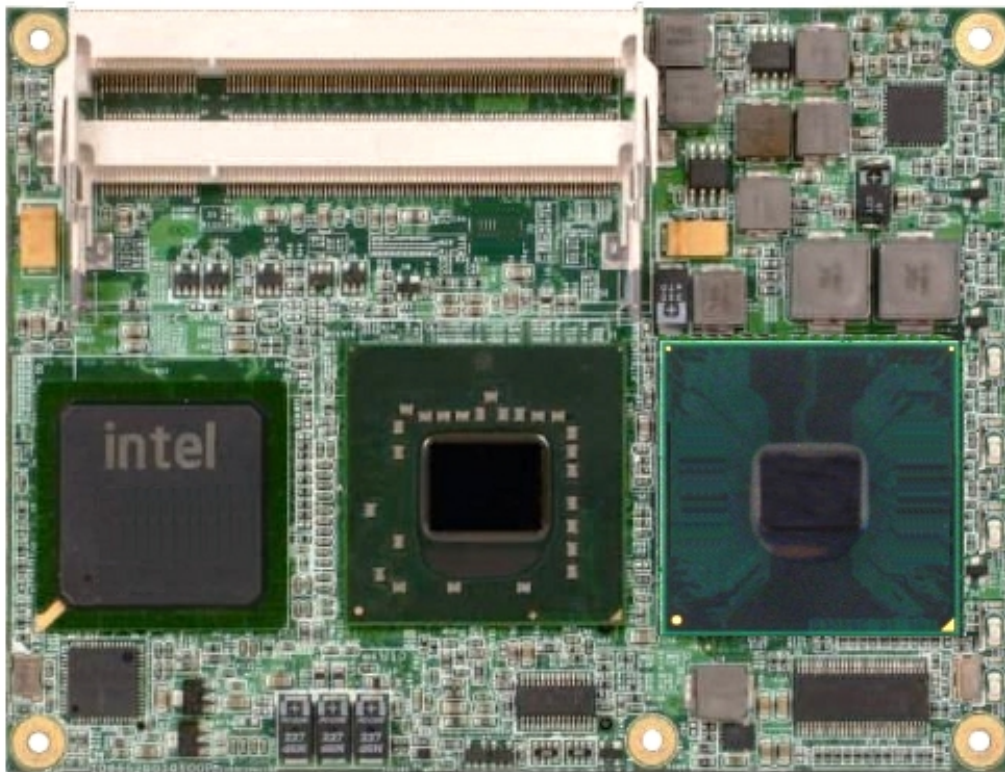




DIAMOND SYSTEMS CORPORATION

CME-965

COM Express Computer-On-Module Based on Intel® Core 2 Duo LV CPU



Revision	Date	Comment
1.0prelim	03/25/10	Release candidate 1

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CONTENTS

IMPORTANT SAFE-HANDLING INFORMATION.....	3
1. INTRODUCTION.....	4
1.1 Features.....	4
2. FUNCTIONAL OVERVIEW.....	6
2.1 Block Diagram.....	6
2.2 Board Dimensions, Mounting Holes, and Connectors.....	7
2.3 Bus and Interface Connector Summary.....	9
2.4 COM Express Bus Connectors.....	9
3. GETTING STARTED.....	10
3.1 COM Express Development Kits.....	11
3.2 Preparing the Hardware.....	11
3.3 Booting the System.....	12
3.4 BIOS Setup Utility.....	12
3.4.1 Main Setup Menu.....	12
3.4.2 Advanced Setup Menu.....	12
3.4.3 PCI/PnP Settings Menu.....	13
3.4.4 Boot Settings Menu.....	13
3.4.5 Security Settings Menu.....	13
3.4.6 Chipset Settings Menu.....	13
3.4.7 Exit.....	14
3.5 Operating System Drivers.....	14
3.6 BIOS Beep Sounds List.....	14
4. INTERFACE CONNECTOR DETAILS.....	15
4.1 COM Express AB Connector.....	16
4.1.1 USB signals.....	18
4.1.2 Gigabit Ethernet (LAN).....	18
4.1.3 AC97 Audio/High Definition Audio.....	18
4.1.4 PCI Express.....	19
4.1.5 SATA.....	19
4.1.6 General Purpose Inputs and Outputs (GPIO).....	20
4.1.7 Power and System Management.....	20
4.1.8 LVDS Flat Panel.....	21
4.1.9 LPC Interface.....	21
4.1.10 Analog VGA (CRT).....	22
4.1.11 TV Out.....	22
4.1.12 Miscellaneous Signals.....	23
4.2 COM Express CD Connector.....	24
4.2.1 IDE (PATA) Bus.....	26
4.2.2 PCI Bus Interface.....	27
4.2.3 PCI Express x16 Graphics (PEG).....	27
5. APPENDIX: SYSTEM RESOURCES REFERENCE.....	29
5.1 BIOS Memory Mapping.....	29
5.2 I/O Port Address Map.....	29
5.3 Interrupt Request (IRQ) Lines.....	30
5.4 BIOS Beep Codes.....	31
5.4.1 Boot Block Beep Codes.....	31
5.4.2 Post BIOS Beep Codes.....	32
5.4.3 Troubleshooting Post BIOS Beep Codes.....	32
5.4.4 Bootblock Initialization Code Checkpoints.....	33
5.4.5 Bootclock Recovery Code Checkpoints.....	34
5.4.6 POST Code Checkpoints.....	35
5.4.7 DIM Code Checkpoints.....	38
5.4.8 ACPI Runtime Checkpoints.....	39

IMPORTANT SAFE-HANDLING INFORMATION



WARNING: ESD-Sensitive Electronic Equipment!

Observe ESD-safe handling procedures when working with this product.

Always use this product in a properly grounded work area and wear appropriate ESD-preventive clothing and/or accessories.

Always store this product in ESD-protective packaging when not in use.

Safe Handling Precautions

The CME-965 contains numerous I/O connectors that connect to sensitive electronic components. This creates many opportunities for accidental damage during handling, installation and connection to other equipment. The list here describes common causes of failure found on boards returned to Diamond Systems for repair. This information is provided as a source of advice to help you prevent damaging your Diamond (or any vendor's) embedded computer boards.

ESD damage – This type of damage is almost impossible to detect, because there is no visual sign of failure or damage. The symptom is that the board simply stops working, because some component becomes defective. Usually the failure can be identified and the chip can be replaced. To prevent ESD damage, always follow proper ESD-prevention practices when handling computer boards.

Damage during handling or storage – On some boards we have noticed physical damage from mishandling. A common observation is that a screwdriver slipped while installing the board, causing a gouge in the PCB surface and cutting signal traces or damaging components.

Another common observation is damaged board corners, indicating the board was dropped. This may or may not cause damage to the circuitry, depending on what is near the corner. Most of our boards are designed with at least 25 mils clearance between the board edge and any component pad, and ground / power planes are at least 20 mils from the edge to avoid possible shorting from this type of damage. However these design rules are not sufficient to prevent damage in all situations.

A third cause of failure is when a metal screwdriver tip slips, or a screw drops onto the board while it is powered on, causing a short between a power pin and a signal pin on a component. This can cause overvoltage / power supply problems described below. To avoid this type of failure, only perform assembly operations when the system is powered off.

Sometimes boards are stored in racks with slots that grip the edge of the board. This is a common practice for board manufacturers. However our boards are generally very dense, and if the board has components very close to the board edge, they can be damaged or even knocked off the board when the board tilts back in the rack. Diamond recommends that all our boards be stored only in individual ESD-safe packaging. If multiple boards are stored together, they should be contained in bins with dividers between boards. Do not pile boards on top of each other or cram too many boards into a small location. This can cause damage to connector pins or fragile components.

Power supply wired backwards – Our power supplies and boards are not designed to withstand a reverse power supply connection. This will destroy each IC that is connected to the power supply. In this case the board will most likely will be unrepairable and must be replaced. A chip destroyed by reverse power or by excessive power will often have a visible hole on the top or show some deformation on the top surface due to vaporization inside the package. **Check twice before applying power!**

1. INTRODUCTION

The CME-965 is a highly integrated computer-on-module (COM) based on the low power, high performance Intel® Core 2 Duo LV processor clocked at up to 1.6GHz. The module is equipped with up to 4GB of DDR2 SDRAM and provides interfaces for high-resolution CRTs and LVDS-interfaced LCDs, PCI Express x16 Graphics (PEG), gigabit Ethernet, SATA drives, IDE, USB peripherals, and audio. Additionally, the CME-965 offers a high degree of system expansion flexibility via the presence of both PCI Express and PCI buses on its COM Express Type 2 compliant baseboard interface connectors.

1.1 Features

- Processor: 1.6GHz Intel Core 2 Duo LV CPU; 800MHz FSB; 4MB L2 cache
- Chipset: Intel 965GME with Intel ICH8M
- 2 200-pin SO-DIMM sockets, for up to 4GB DDR2 SDRAM (533/667MHz)
- Graphics:
 - Chipset: Integrated Intel® Graphics Media Accelerator x3100
 - Provides three display interfaces:
 - Analog VGA RGB support up to 2048 x 1536 resolution
 - TV-out support NTSC/PAL up to HDTV 1080P
 - LCD: Dual Channel 24-bit LVDS
- Audio:
 - AC'97 link
 - Mic in, line in/out signals
- USB interfaces: 8 USB 2.0 ports
- Networking: 10/100/1000 Mbps Ethernet (Realtek RTL8111B PCIe Gigabit Ethernet controller)
- Mass storage interface:
 - 3 SATA ports with 150MB/s max. data rate
 - 1 PATA port supports 2 IDE devices
- Keyboard/mouse: USB keyboard/mouse devices supported
- Other:
 - PC speaker interface
 - Watchdog timer with 1-255 levels, reset
 - 8-bit programmable digital I/O port
 - I2C, SMBus serial buses
- Four system expansion buses:
 - 1 PCI Express x16
 - 4 PCI Express x1
 - 4 32-bit PCI bus masters
 - LPC bus
- Power:
 - +12VDC main power; +5VDC standby power
 - Power requirement: 12W idle, 24W loaded (preliminary)
 - Real-time clock backup: 2.0 to 3.6 VDC @ (tbd)
- Operating environment:
 - Operating temperature -40°C to +85°C
 - Operating humidity 0 to 90% (non-condensing)
- Dimensions:
 - COM Express compliant form-factor

- 4.9 x 3.7 inches (125 x 95 mm)
- Weight: 2.8 oz (79 g)
- Software:
 - BIOS: AMI PnP flash BIOS
 - Operating systems supported: Windows XP and Linux 2.6

Note: The COM Express specification is available from the PICMG organization (<http://www.picmg.org>). The COM Express Tutorial and COM Express Design Guide are available for download from the PICMG organization COM Express website located at: <http://www.picmg.org/v2internal/COMExpress.htm>

2. FUNCTIONAL OVERVIEW

2.1 Block Diagram

Figure 1 shows the CME-965 functional blocks, bus, and peripheral interface signals.

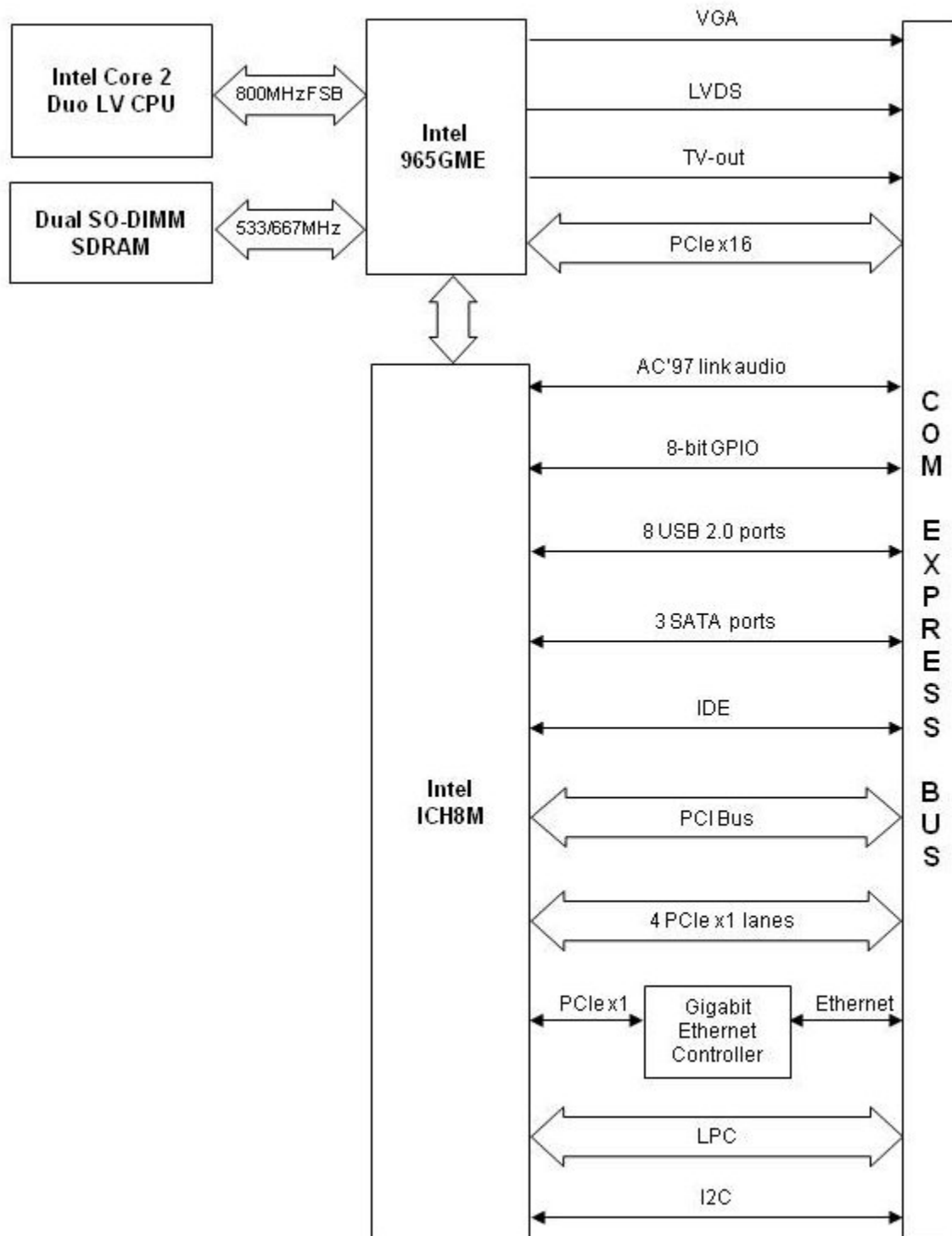
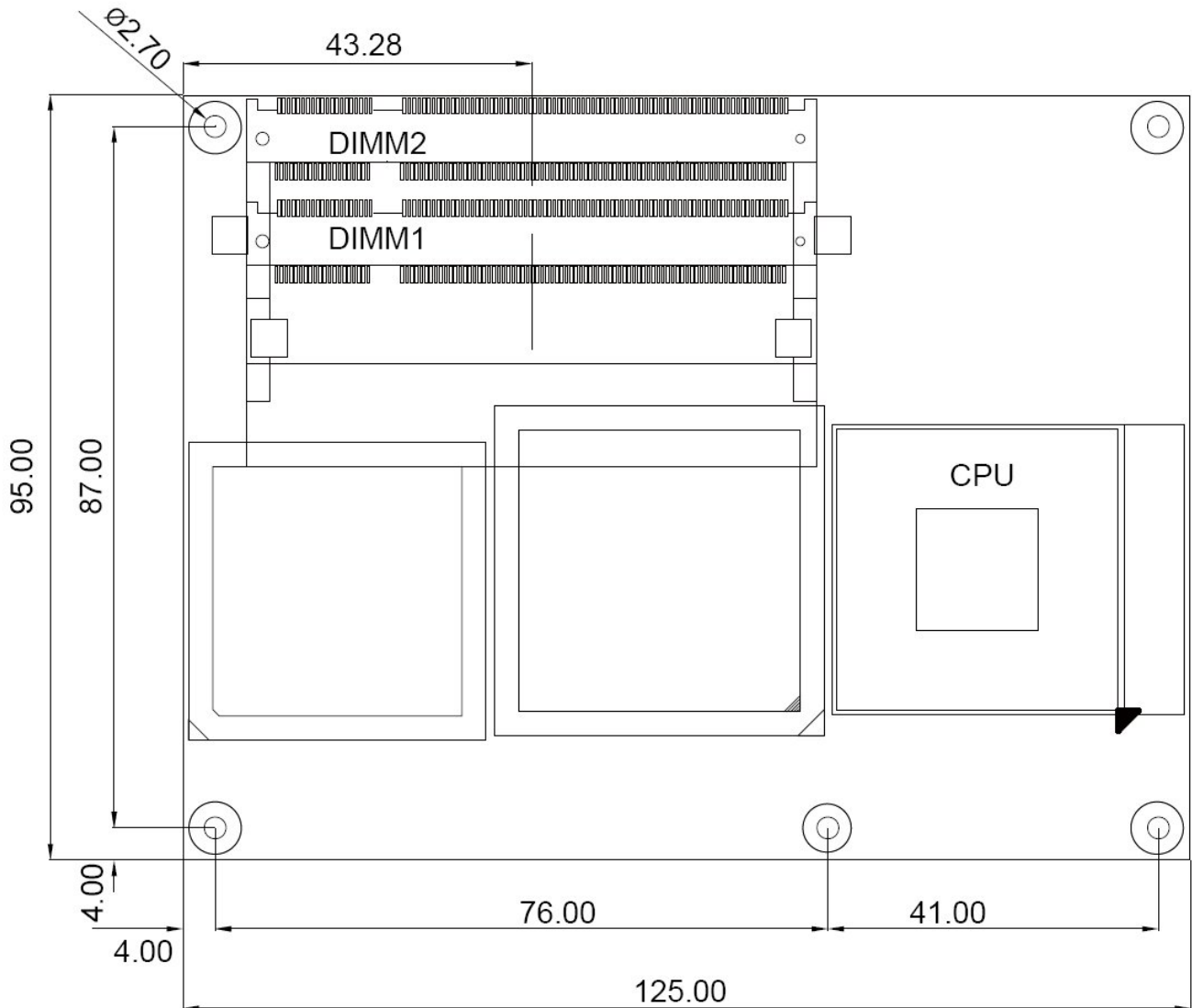


Figure 1: Functional Block Diagram

2.2 Board Dimensions, Mounting Holes, and Connectors

The two diagrams below show the mechanical dimensions of the CME-965's board outline and five mounting holes, as well as the position of all connectors on both the top and bottom sides of the board.



Unit: mm

Figure 2: Board Layout – Top

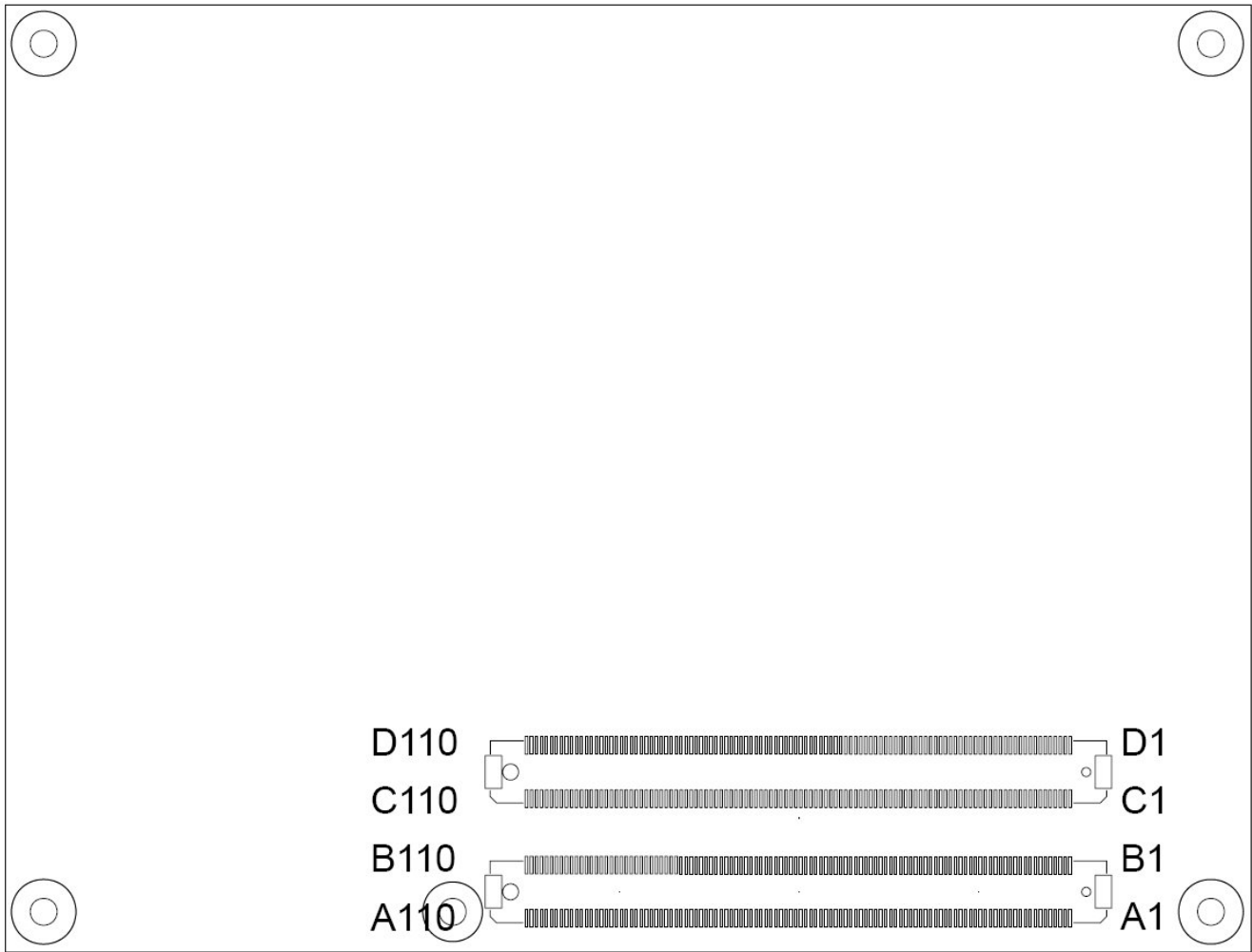


Figure 3: Board Layout – Bottom

2.3 Bus and Interface Connector Summary

The CME-965 has two 2x110-pin interface connectors, as listed in the tables below which are defined in accordance with the PICMG COM Express Specification. Signal functions relating to all of the module's interface connectors are discussed in greater detail in Section 4 of this document.

2.4 COM Express Bus Connectors

<i>Connector</i>	<i>Location</i>	<i>Pins</i>	<i>Function</i>
COMX AB	Bottom	2x110	USB, GigE, PCI Express, AC97 (audio), SATA, LVDS, LPC, VGA (CRT), LAN, TV Out, power and ground interfaces, and system and power management.
COMX CD	Bottom	2x110	PCI bus, IDE (PATA) bus, PCI Express x16 Graphics (PEG), and power and ground signals.

3. GETTING STARTED

This section of the CME-965 User Manual covers basic hardware setup, power connection, system boot-up, and initial software configuration. First-time CME-965 users normally receive the product in conjunction with one of Diamond's Development Kits, which provide everything needed to ensure rapid application development.

Important Safe-Handling Information



WARNING: ESD-Sensitive Electronic Equipment!

Observe ESD-safe handling procedures when working with this product.

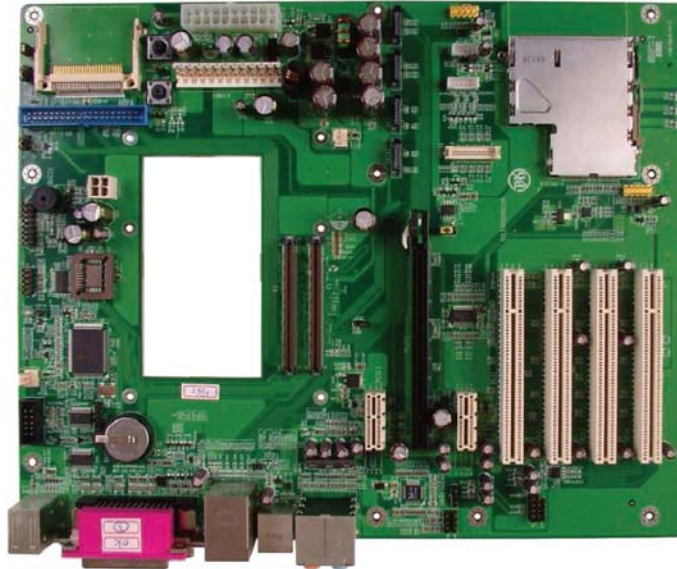
Always use this product in a properly grounded work area and wear appropriate ESD-preventive clothing and/or accessories.

Always store this product in ESD-protective packaging when not in use.

Please refer to page 3 of this manual ("Important Safe-Handling Information") for further details.

3.1 COM Express Development Kits

To facilitate evaluation and development, Diamond's COM Express are normally supplied in conjunction with one of Diamond's COM Express development kits (pictured below). This approach increases project efficiency and reduces risks by providing a known good environment for rapid application development.



ATX form-factor COM Express Development Kit

The baseboards in Diamond's COM Express development kits provide standardized I/O connectors, for quick and easy access to nearly all system interfaces. They also feature a variety of expansion slots and sockets, for flexible system expansion. The kits – which include both generic models and application-oriented baseboards in various form-factors – also generally extend the COM Express module's functionality by adding Ethernet and serial ports, solid-state media sockets, and more. Additionally, the kits typically include an comprehensive set of interface cables, drivers for Linux and Windows operation, and full documentation.

3.2 Preparing the Hardware

If it is not already installed on the baseboard, carefully plug the CME-965 into the baseboard's COM Express bus connectors. Place the heatsink or heat-spreader supplied with the CME-965 on top of the module, carefully positioning it so that its mounting holes line up with those of the module. Then, affix the module and heatsink to the baseboard using the provided hardware.

Connect a USB keyboard, USB mouse, monitor, and mass storage devices to the appropriate connectors on the baseboard. Refer to the baseboard's User Manual for peripheral compatibility and interface cabling considerations.

3.3 Booting the System

Power-up the display, then power-up the system power supply.

The CME-965 module should begin its boot-up sequence immediately, as evidenced by BIOS messages on the connected display. You can use the BIOS Setup utility and install an operating system on the boot drive just as you would on a normal desktop PC.

3.4 BIOS Setup Utility

The BIOS Setup utility program is used for specifying the system configurations and settings. The BIOS ROM of the system stores the Setup utility. When you turn on the computer, the BIOS is immediately activated. The following menus/options are available:

- **Main Setup Menu**
- **Advanced Setup Menu**
- **PCI/PnP Setup Menu**
- **Boot Setup Menu**
- **Security Setup Menu**
- **Chipset Setup Menu**
- **Exit**

Use the left/right arrow keys to highlight a particular configuration screen from the top menu bar, or use the down arrow key to access and configure the information in the menus which are described below.

3.4.1 Main Setup Menu

This menu allows you to select configuration options for the following:

- System Time
- System Date

3.4.2 Advanced Setup Menu

This menu allows you to select configuration options for the following:

- CPU Configuration – Settings for Hardware Prefetcher, Adjacent Cache Line Prefetch, Cache L1 & L2, Max CPUID Value Limit, Vanderpool Technology, Core Multi-Processing, and Intel® SpeedStep™ Tech.
- IDE Configuration – Settings for hard drives (Primary/Secondary/Third IDE, Master/Slave)
- Floppy Configuration – Settings for the type of floppy drive installed on the system.
- Super IO Configuration – Settings for Onboard Floppy Controller, Serial Port1 / Port2 Address, Serial Port2 Mode, Parallel Port Address, Parallel Port Mode, Parallel Port IRQ, Restore on AC Power Loss by IO.
- Hardware Health Configuration – Settings for System/ CPU Temperature 1, CPU / System Fan Speed, Vcore (CPU voltage), +5.0V / +3.3V / +12.0V / 5Vsb / VBAT (standby and battery voltage).
- ACPI Configuration – Settings for Suspend mode.
- AHCI Configuration – Settings for AHCI Ports.
- APM Configuration – Settings for Power Management/APM, Video Power Down Mode, Hard Disks Power Down Mode, Suspend Time Out, Keyboard & PS/2 Mouse, Power Button Mode, Advanced Resume Event Controls, Resume on PME#, Resume on RTC Alarm.

- MPS Configuration – Settings for MPS Revision (multi-processor version control).
- USB Configuration – Settings for Legacy USB Support, USB 2.0 Controller Mode, BIOS EHCI Hand-Off, USB Mass Storage Reset Delay, Emulation Type (floppy/hard drive).
- Remote Access Configuration – Settings for Remote Access, Serial port number, Base Address IRQ.

3.4.3 PCI/PnP Settings Menu

This menu allows you to select configuration options for the following:

- Clear NVRAM
- Plug & Play O/S
- PCI Latency Timer
- Allocate IRQ to PCI VGA
- IRQ3 - IRQ15
- DMA Channel 0 - DMA Channel 7
- Reserved Memory Size

3.4.4 Boot Settings Menu

This menu allows you to select configuration options for the following:

- Boot Device Priority
- Hard Disk Drives
- Removable Drives
- Quick Boot
- Bootup Num-Lock
- LAN Boot Function

3.4.5 Security Settings Menu

This menu allows you to select configuration options for the following:

- Supervisor Password & User Password
- Boot Sector Virus Protection

3.4.6 Chipset Settings Menu

This menu allows you to select configuration options for the following:

- North Bridge Chipset Configuration – Settings for Boots Graphic Adapter Priority, Internal Graphic Mode Select, Video Function Configuration, DVMT Mode and Memory, Boot Display (CRT, LVDS), Flat Panel Type, TV Standard, Spread Spectrum Clock.

- South Bridge Chipset Configuration – Settings for USB Function (active ports), USB 2.0 Controller, HDA Controller, SLP_S4# Min. Assertion Width, Onboard LAN1.

3.4.7 Exit

This selection saves changes and exits the BIOS Setup Utility.

3.5 Operating System Drivers

Drivers for Windows XP and Linux 2.6, if required, are included on the Software and Documentation CD that is provided along with the CME-965 or in its Development Kit. To locate the CME-965 module's software drivers on the CD, view the index.html file in the CD's root directory, locate "Computer-on-Modules," and then click on "CME-965." This software is also available for download from [Diamond's website](#).

3.6 BIOS Beep Sounds List

Post BIOS Beep Codes

<i>Number of Beeps</i>	<i>Description</i>
1	Memory refresh timer error.
2	Parity error in base memory (first 64KB block)
3	Base memory read/write test error
4	Motherboard timer not operational
5	Processor error
6	8042 Gate A20 test error (cannot switch to protected mode)
7	General exception error (processor exception interrupt error)
8	Display memory error (system video adapter)
9	AMIBIOS ROM checksum error
10	CMOS shutdown register read/write error

More BIOS information is included in the Appendix.

4. INTERFACE CONNECTOR DETAILS

This section describes the functions available on the COM Express AB and CD interface connectors.

Note: The COM Express specification is available from the PICMG organization (<http://www.picmg.org>). The COM Express Tutorial and COM Express Design Guide are available for download from the PICMG organization COM Express website located at: <http://www.picmg.org/v2internal/COMExpress.htm>.

4.1 COM Express AB Connector

The 2x110-pin, high-density COM Express AB connector implements the board's USB, PCI Express, SATA, LVDS, LPC, AC97 (audio), VGA (CRT), LAN, power and ground interfaces, and system and power management, as indicated in the table below. Further information regarding each of these signal groups follows the table. (Note: Pins designated "NC" should be left unconnected.)

GND	B1	A1	GND	USB7-	B36	A36	USB6-
GBE0_ACT#	B2	A2	GBE0_MDI3-	USB7+	B37	A37	USB6+
LPC_FRAME#	B3	A3	GBE0_MDI3+	USB_4_5_OC#	B38	A38	USB_6_7_OC#
LPC_AD0	B4	A4	GBE0_LINK100#	USB5-	B39	A39	USB4-
LPC_AD1	B5	A5	GBE0_LINK1000#	USB5+	B40	A40	USB4+
LPC_AD2	B6	A6	GBE0_MDI2-	GND	B41	A41	GND
LPC_AD3	B7	A7	GBE0_MDI2+	USB3-	B42	A42	USB2-
LPC_DRQ0#	B8	A8	NC	USB3+	B43	A43	USB2+
LPC_DRQ1#	B9	A9	GBE0_MDI1-	USB_0_1_OC#	B44	A44	USB_2_3_OC#
LPC_CLK	B10	A10	GBE0_MDI1+	USB1-	B45	A45	USB0-
GND	B11	A11	GND	USB1+	B46	A46	USB0+
PWRBTN#	B12	A12	GBE0_MDI0-	EXCD1_PERST#	B47	A47	VCC_RTC
SMB_CK	B13	A13	GBE0_MDI0+	EXCD1_CPPE#	B48	A48	EXCD0_PERST#
SMB_DAT	B14	A14	GBE0_CTREF	SYS_RESET#	B49	A49	EXCD0_CPPE#
SMB_ALERT#	B15	A15	SUS_S3#	CB_RESET#	B50	A50	LPC_SERIRQ
SATA1_TX+	B16	A16	SATA0_TX+	GND	B51	A51	GND
SATA1_TX-	B17	A17	SATA0_TX-	NC	B52	A52	NC
SUS_STAT#	B18	A18	SUS_S4#	NC	B53	A53	NC
SATA1_RX+	B19	A19	SATA0_RX+	GPO1	B54	A54	GPI0
SATA1_RX-	B20	A20	SATA0_RX-	NC	B55	A55	NC
GND	B21	A21	GND	NC	B56	A56	NC
NC	B22	A22	SATA2_TX+	GPO2	B57	A57	GND
NC	B23	A23	SATA2_TX-	PCIE_RX3+	B58	A58	PCIE_TX3+
PWR_OK	B24	A24	SUS_S5#	PCIE_RX3-	B59	A59	PCIE_TX3-
NC	B25	A25	SATA2_RX+	GND	B60	A60	GND
NC	B26	A26	SATA2_RX-	PCIE_RX2+	B61	A61	PCIE_TX2+
WDT	B27	A27	BATLOW#	PCIE_RX2-	B62	A62	PCIE_TX2-
AC_SDIN2	B28	A28	SATA_ACT#	GPO3	B63	A63	GPI1
AC_SDIN1	B29	A29	AC_SYNC	PCIE_RX1+	B64	A64	PCIE_TX1+
AC_SDIN0	B30	A30	AC_RST#	PCIE_RX1-	B65	A65	PCIE_TX1-
GND	B31	A31	GND	WAKE0#	B66	A66	GND
SPKR	B32	A32	AC_BITCLK	WAKE1#	B67	A67	GPI2
I2C_CK	B33	A33	AC_SDOUT	PCIE_RX0+	B68	A68	PCIE_TX0+
I2C_DAT	B34	A34	BIOS_DISABLE#	PCIE_RX0-	B69	A69	PCIE_TX0-
THRM#	B35	A35	THRMTRIP#	GND	B70	A70	GND

LVDS_B0+	B71	A71	LVDS_A0+	VGA_GRN	B91	A91	RSVD
LVDS_B0-	B72	A72	LVDS_A0-	VGA_BLU	B92	A92	RSVD
LVDS_B1+	B73	A73	LVDS_A1+	VGA_HSYNC	B93	A93	GPO0
LVDS_B1-	B74	A74	LVDS_A1-	VGA_VSYNC	B94	A94	RSVD
LVDS_B2+	B75	A75	LVDS_A2+	VGA_I2C_CK	B95	A95	RSVD
LVDS_B2-	B76	A76	LVDS_A2-	VGA_I2C_DAT	B96	A96	GND
NC	B77	A77	LVDS_VDD_EN	TV_DAC_A	B97	A97	VCC_12V
NC	B78	A78	NC	TV_DAC_B	B98	A98	VCC_12V
LVDS_BKLT_EN	B79	A79	NC	TV_DAC_C	B99	A99	VCC_12V
GND	B80	A80	GND	GND	B100	A100	GND
LVDS_B_CK+	B81	A81	LVDS_A_CK+	VCC_12V	B101	A101	VCC_12V
LVDS_B_CK-	B82	A82	LVDS_A_CK-	VCC_12V	B102	A102	VCC_12V
CKLVDS_BKLT_CTRL	B83	A83	LVDS_I2C_CK	VCC_12V	B103	A103	VCC_12V
VCC_5V_SBY	B84	A84	LVDS_I2C_DAT	VCC_12V	B104	A104	VCC_12V
VCC_5V_SBY	B85	A85	GPI3	VCC_12V	B105	A105	VCC_12V
VCC_5V_SBY	B86	A86	KBD_RST#	VCC_12V	B106	A106	VCC_12V
VCC_5V_SBY	B87	A87	KBD_A20GATE	VCC_12V	B107	A107	VCC_12V
RSVD	B88	A88	PCIE_CLK_REF+	VCC_12V	B108	A108	VCC_12V
VGA_RED	B89	A89	PCIE_CLK_REF-	VCC_12V	B109	A109	VCC_12V
GND	B90	A90	GND	GND	B110	A110	GND

4.1.1 USB signals

These pins provide connections to the board's eight USB channels. For further information regarding the functions of the USB signals listed above, refer to the USB 2.0 Specification, available from the USB Implementers Forum (<http://www.usb.org>).

Signal Name	Signal Function	Direction
USB[0:7]+ USB[0:7]-	USB differential pairs, data channels 0 through 7.	I/O
USB_0_1_OC#	USB over-current sense, USB channels 0 and 1.	I
USB_2_3_OC#	USB over-current sense, USB channels 2 and 3.	I
USB_4_5_OC#	USB over-current sense, USB channels 4 and 5.	I
USB_6_7_OC#	USB over-current sense, USB channels 6 and 7.	I

4.1.2 Gigabit Ethernet (LAN)

These pins provide connections to the GigE (LAN) interface.

Signal Name	Signal Function	Direction
GBE0_MDI[0:3]+ GBE0_MDI[0:3]-	Gigabit Ethernet Controller 0: Media Dependent Interface Differential Pairs 0,1,2,3.	I/O
GBE0_ACT#	Gigabit Ethernet Controller 0 activity indicator.	O
GBE0_LINK#	Gigabit Ethernet Controller 0 link indicator.	O
GBE0_LINK100#	Gigabit Ethernet Controller 0 100 Mbit / sec link indicator.	O
GBE0_LINK1000#	Gigabit Ethernet Controller 0 1000 Mbit / sec link indicator.	O
GBE0_CTREF	Reference voltage for carrier board Ethernet channel 0 magnetics center tap.	REF

4.1.3 AC97 Audio/High Definition Audio

These pins provide connections to the high definition audio interface.

Signal Name	Signal Function	Direction
AC_RST#	Reset output to AC97 CODEC.	O
AC_SYNC	48kHz fixed-rate, sample-synchronization signal to the CODEC(s).	O
AC_BITCLK	12.228 MHz serial data clock generated by the external CODEC(s).	O
AC_SDOUT	Serial TDM data output to the CODEC.	O
AC_SDIN[0:2]	Serial TDM data inputs from up to 3 CODECs/	I

4.1.4 PCI Express

These pins provide connections to the general purpose PCI Express interface and card.

Signal Name	Signal Function	Direction
PCIE_TX[0:3]+ PCIE_TX[0:3]-	PCI Express Differential Transmit Pairs 0 through 3.	O
PCIE_RX[0:3]+ PCIE_RX[0:3]-	PCI Express Differential Receive Pairs 0 through 3.	I
PCIE_CLK_REF+/-	Reference clock output for all PCI Express and PCI Express Graphics lanes.	O
EXCD[0:1]_CPPE#	PCI Express Card capable card request, active low, one per card.	I
EXCD[0:1]_PERST#	PCI Express Card reset, active low, one per card.	O
PCI_RESET#	PCI Reset output, active low.	O
WAKE0#	PCI Express wake up signal.	I

4.1.5 SATA

These pins carry the three Serial ATA port signals.

Signal Name	Signal Function	Direction
SATA0_TX+ SATA0_TX	Serial ATA Channel 0 transmit differential pair.	O
SATA0_RX+ SATA0_RX	Serial ATA Channel 0 receive differential pair.	I
SATA1_TX+ SATA1_TX	Serial ATA Channel 1 transmit differential pair.	O
SATA1_RX+ SATA1_RX	Serial ATA Channel 1 receive differential pair.	I
SATA2_TX+ SATA2_TX	Serial ATA Channel 2 transmit differential pair.	O
SATA2_RX+ SATA2_RX	Serial ATA Channel 2 receive differential pair.	I
SATA_ACT#	SATA activity indicator LED.	O

4.1.6 General Purpose Inputs and Outputs (GPIO)

These pins carry four general purpose input lines and four general purpose outputs.

Signal Name	Signal Function	Direction
GPO[0:3]	General purpose output pins.	O
GPI[0:3]	General purpose input pins.	I

4.1.7 Power and System Management

These pins support various power management and control functions.

Signal Name	Signal Function	Direction
PWRBTN#	Power button to bring system out of S5 (soft off), active on rising edge.	I
SYS_RESET#	Reset button input.	I
CB_RESET#	Reset output from module to carrier board.	O
PWR_OK	Power OK from main power supply.	I
SUS_STAT#	Indicates imminent suspend operation; used to notify LPC devices.	O
SUS_S3#	Indicates system is in Suspend to RAM state.	O
SUS_S4#	Indicates system is in Suspend to Disk state.	O
SUS_S5#	Indicates system is in Soft Off state. Also known as "PS_ON" and can be used to control an ATX power supply.	O
WAKE0#	PCI Express wake up signal.	I
WAKE1#	General purpose wake up signal.	I
BATLOW#	Indicates that external battery is low.	I
THRM#	Input from off-module temp sensor indicating an over-temp situation.	I
THERMTRIP#	Active low output indicating that the CPU has entered thermal shutdown.	O
SMB_CK	System Management Bus bidirectional clock line.	I/O
SMB_DAT	System Management Bus bidirectional data line.	I/O
SMB_ALERT#	System Management Bus Alert..	I

4.1.8 LVDS Flat Panel

These pins carry data for graphical display on an LVDS panel, as indicated.

Signal Name	Signal Function	Direction
LVDS_A[0:3]+ LVDS_A[0:3]-	LVDS Channel A differential pairs.	O
LVDS_A_CK+ LVDS_A_CK	LVDS Channel A differential clock.	O
LVDS_B[0:3]+ LVDS_B[0:3]-	LVDS Channel B differential pairs.	O
LVDS_B_CK+ LVDS_B_CK	LVDS Channel B differential clock.	O
LVDS_VDD_EN	LVDS panel power enable.	O
LVDS_BKLT_EN	LVDS panel backlight enable.	O
LVDS_BKLT_CTRL	LVDS panel backlight brightness control.	O
LVDS_I2C_CK	I2C clock output for LVDS display use.	O
LVDS_I2C_DAT	I2C data line for LVDS display use.	I/O

4.1.9 LPC Interface

These pins carry the Low Pin Count (LPC) interface signals, as indicated.

Signal Name	Signal Function	Direction
LPC_AD[0:3]	LPC multiplexed address, command and data bus.	I/O
LPC_FRAME#	LPC frame indicates the start of an LPC cycle.	O
LPC_DRQ[0:1]#	LPC serial DMA request.	I
LPC_SERIRQ	LPC serial interrupt.	I/O
LPC_CLK	LPC clock output.	O

4.1.10 Analog VGA (CRT)

These pins carry video and timing data for graphical display on a TV device, as indicated.

Signal Name	Signal Function	Direction
VGA_RED	Red for monitor. Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O
VGA_GRN	Green for monitor. Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O
VGA_BLU	Blue for monitor. Analog DAC output, designed to drive a 37.5-Ohm equivalent load.	O
VGA_HSYNC	Horizontal sync output to VGA monitor	O
VGA_VSYNC	Vertical sync output to VGA monitor	O
VGA_I2C_CK	DDC clock line (I2C port dedicated to identify VGA monitor capabilities)	O
VGA_I2C_DAT	DDC data line.	I/O

4.1.11 TV Out

These pins carry the composite video out signals.

Signal Name	Signal Function	Direction
TV_DAC_A	TVDAC Channel A Output supports the following: Composite video: CVBS Component video: Chrominance (Pb) analog signal S-Video: not used	O
TV_DAC_B	TVDAC Channel B Output supports the following: Composite video: not used Component video: Luminance (Y) analog signal. S-Video: Luminance analog signal.	O
TV_DAC_C	TVDAC Channel C Output supports the following: Composite video: not used Component: Chrominance (Pr) analog signal. S-Video: Chrominance analog signal.	O

4.1.12 Miscellaneous Signals

These pins carry the I2C bus plus a number of utility signals.

<i>Signal Name</i>	<i>Signal Function</i>	<i>Direction</i>
I2C_CK	General purpose I2C port clock output.	O
I2C_DAT	General purpose I2C port data I/O line.	I/O
SPKR	Output for audio enunciator - the "speaker" in PC-AT systems	O
BIOS_DISABLE#	Module BIOS disable input.	I
WDT	Output indicating that a watchdog time-out event has occurred.	O
KBD_RST#	Input to module from (optional) external keyboard controller that can force a reset.	I
KBD_A20GATE	Input to module from (optional) external keyboard controller.	I

4.2 COM Express CD Connector

The 210-pin, high-density COM Express CD connector implements the IDE (PATA) bus, PCI bus, PCI Express x16 Graphics (PEG), and power and ground signals as indicated in the table below. (Note: Pins designated “NC” should be left unconnected.)

GND	D1	C1	GND	PCI_FRAME#	D36	C36	PCI_DEVSEL#
IDE_D5	D2	C2	IDE_D7	PCI_AD16	D37	C37	PCI_IRDY#
IDE_D10	D3	C3	IDE_D6	PCI_AD18	D38	C38	PCI_C/BE2#
IDE_D11	D4	C4	IDE_D3	PCI_AD20	D39	C39	PCI_AD17
IDE_D12	D5	C5	IDE_D15	PCI_AD22	D40	C40	PCI_AD19
IDE_D4	D6	C6	IDE_D8	GND	D41	C41	GND
IDE_D0	D7	C7	IDE_D9	PCI_AD24	D42	C42	PCI_AD21
IDE_REQ	D8	C8	IDE_D2	PCI_AD26	D43	C43	PCI_AD23
IDE_IOW#	D9	C9	IDE_D13	PCI_AD28	D44	C44	PCI_C/BE3#
IDE_ACK#	D10	C10	IDE_D1	PCI_AD30	D45	C45	PCI_AD25
GND	D11	C11	GND	PCI_IRQC#	D46	C46	PCI_AD27
IDE_IRQ	D12	C12	IDE_D14	PCI_IRQD#	D47	C47	PCI_AD29
IDE_A0	D13	C13	IDE_IORDY	PCI_CLKRUN#	D48	C48	PCI_AD31
IDE_A1	D14	C14	IDE_IOR#	PCI_M66EN	D49	C49	PCI_IRQA#
IDE_A2	D15	C15	PCI_PME#	PCI_CLK	D50	C50	PCI_IRQB#
IDE_CS1#	D16	C16	PCI_GNT2#	GND	D51	C51	GND (FIXED)
IDE_CS3#	D17	C17	PCI_REQ2#	PEG_TX0+	D52	C52	PEG_RX0+
IDE_RESET#	D18	C18	PCI_GNT1#	PEG_TX0-	D53	C53	PEG_RX0-
PCI_GNT3#	D19	C19	PCI_REQ1#	PEG_LANE_RV#	D54	C54	TYPE0#
PCI_REQ3#	D20	C20	PCI_GNT0#	PEG_TX1+	D55	C55	PEG_RX1+
GND	D21	C21	GND	PEG_TX1-	D56	C56	PEG_RX1-
PCI_AD1	D22	C22	PCI_REQ0#	TYPE2#	D57	C57	TYPE1#
PCI_AD3	D23	C23	PCI_RESET#	PEG_TX2+	D58	C58	PEG_RX2+
PCI_AD5	D24	C24	PCI_AD0	PEG_TX2-	D59	C59	PEG_RX2-
PCI_AD7	D25	C25	PCI_AD2	GND	D60	C60	GND
PCI_C/BE0#	D26	C26	PCI_AD4	PEG_TX3+	D61	C61	PEG_RX3+
PCI_AD9	D27	C27	PCI_AD6	PEG_TX3-	D62	C62	PEG_RX3-
PCI_AD11	D28	C28	PCI_AD8	RSVD	D63	C63	RSVD
PCI_AD13	D29	C29	PCI_AD10	RSVD	D64	C64	RSVD
PCI_AD15	D30	C30	PCI_AD12	PEG_TX4+	D65	C65	PEG_RX4+
GND	D31	C31	GND	PEG_TX4-	D66	C66	PEG_RX4-
PCI_PAR	D32	C32	PCI_AD14	GND	D67	C67	RSVD
PCI_SERR#	D33	C33	PCI_C/BE1#	PEG_TX5+	D68	C68	PEG_RX5+
PCI_STOP#	D34	C34	PCI_PERR#	PEG_TX5-	D69	C69	PEG_RX5-
PCI_TRDY#	D35	C35	PCI_LOCK#	GND	D70	C70	GND

PEG_TX6+	D71	C71	PEG_RX6+	PEG_TX12+	D91	C91	PEG_RX12+
PEG_TX6-	D72	C72	PEG_RX6-	PEG_TX12-	D92	C92	PEG_RX12-
SDVO_I2C_CLK	D73	C73	SDVO_I2C_DATA	GND	D93	C93	GND
PEG_TX7+	D74	C74	PEG_RX7+	PEG_TX13+	D94	C94	PEG_RX13+
PEG_TX7-	D75	C75	PEG_RX7-	PEG_TX13-	D95	C95	PEG_RX13-
GND	D76	C76	GND	GND	D96	C96	GND
IDE_CBLID#	D77	C77	RSVD	PEG_ENABLE#	D97	C97	RSVD
PEG_TX8+	D78	C78	PEG_RX8+	PEG_TX14+	D98	C98	PEG_RX14+
PEG_TX8-	D79	C79	PEG_RX8-	PEG_TX14-	D99	C99	PEG_RX14-
GND	D80	C80	GND	GND	D100	C100	GND
PEG_TX9+	D81	C81	PEG_RX9+	PEG_TX15+	D101	C101	PEG_RX15+
PEG_TX9-	D82	C82	PEG_RX9-	PEG_TX15-	D102	C102	PEG_RX15-
RSVD	D83	C83	RSVD	GND	D103	C103	GND
GND	D84	C84	GND	VCC_12V	D104	C104	VCC_12V
PEG_TX10+	D85	C85	PEG_RX10+	VCC_12V	D105	C105	VCC_12V
PEG_TX10-	D86	C86	PEG_RX10-	VCC_12V	D106	C106	VCC_12V
GND	D87	C87	GND	VCC_12V	D107	C107	VCC_12V
PEG_TX11+	D88	C88	PEG_RX11+	VCC_12V	D108	C108	VCC_12V
PEG_TX11-	D89	C89	PEG_RX11-	VCC_12V	D109	C109	VCC_12V
GND	D90	C90	GND	GND	D110	C110	GND

4.2.1 IDE (PATA) Bus

This set of pins implements the module's IDE bus which provide a single channel IDE interface supporting two standard IDE hard drives.

Signal Name	Signal Function	Direction
IDE_D[0:15]	Bidirectional data to / from IDE device.	I/O
IDE_A[0:2]	Address lines to IDE device.	O
IDE_IOW#	I/O write line to IDE device. Data latched on trailing (rising) edge.	O
IDE_IOR#	I/O read line to IDE device.	O
IDE_REQ	IDE Device DMA Request. It is asserted by the IDE device to request a data transfer.	I
IDE_ACK#	IDE Device DMA Acknowledge.	O
IDE_CS1#	IDE Device Chip Select for 1F0h to 1FFh range.	O
IDE_CS3#	IDE Device Chip Select for 3F0h to 3FFh range.	O
IDE_IORDY	IDE device I/O ready input.	I
IDE_RESET#	Reset output to IDE device.	O
IDE_IRQ	Interrupt request from IDE device.	I
IDE_CBLID#	Input from off-module hardware indicating the type of IDE cable being used. High indicates a 40-pin cable used for legacy IDE modes. Low indicates that an 80-pin cable with interleaved grounds is used. Such a cable is required for Ultra-DMA 66,100 and 133 modes.	I

4.2.2 PCI Bus Interface

This set of pins implements the module's PCI expansion bus. For further information regarding the functions of the PCI bus signals, refer to the PCI Bus Specification, available from the PCI Special Interest Group (<http://www.pcisig.com/specifications>).

Signal Name	Signal Function	Direction
PCI_AD[0:31]	PCI bus multiplexed address and data lines	I/O
PCI_C/BE[0:3]#	PCI bus byte enable lines, active low	I/O
PCI_DEVSEL#	PCI bus Device Select.	I/O
PCI_FRAME#	PCI bus Frame control line.	I/O
PCI_IRDY#	PCI bus Initiator Ready control line.	I/O
PCI_TRDY#	PCI bus Target Ready control line.	I/O
PCI_STOP#	PCI bus STOP control line.	I/O
PCI_PAR	PCI bus parity	I/O
PCI_PERR#	Parity Error:.	I/O
PCI_REQ[0:3]#	PCI bus master request input lines.	I
PCI_GNT[0:3]#	PCI bus master grant output lines.	O
PCI_RESET#	PCI Reset output.	O
PCI_LOCK#	PCI Lock control line.	I/O
PCI_SERR#	System Error: SERR# may be pulsed active by any PCI device that detects a system error condition.	I/O
PCI_PME#	PCI Power Management Event: PCI peripherals drive PME# to wake system from low-power states S1–S5.	I
PCI_CLKRUN#	Bidirectional pin used to support PCI clock run protocol for mobile systems.	I/O
PCI_IRQ[A:D]#	PCI interrupt request lines.	I
PCI_CLK	PCI 33MHz clock output.	O
PCI_M66EN	Pull down strap.	I

4.2.3 PCI Express x16 Graphics (PEG)

This set of pins drives a PCIe x16 link for an external high-performance PCI Express Graphics card,

Note: The pins of the PEG Port might be shared with other functionality like SDVO or DVO, depending on the chipset used. SDVO and PEG are defined on the COM Express specification which is available from the PICMG organization (<http://www.picmg.org>).

Signal Name	Signal Function	Direction
PEG_RX[0:15]+ PEG_RX[0:15]-	PCI Express Graphics receive differential pairs.	I
PEG_TX[0:15]+ PEG_TX[0:15]-	PCI Express Graphics transmit differential pairs.	O

PCIE_CLK_REF+	Reference clock output for all PCI Express and PCI	O
PCIE_CLK_REF-	Express Graphics lanes.	
PEG_LANE_RV#	PCI Express Graphics lane reversal input strap. Pull low on the carrier board to reverse lane order.	I
PEG_ENABLE#	PEG Enable function. Strap to enable PCI Express x16 external graphics interface. Pull low to disable internal graphics and enable the x16 interface.	I
SDVO_I2C_CLK	I2C based control signal (clock) for SDVO device.	O
SDVO_I2C_DATA	I2C based control signal (data) for SDVO device.	I/O

5. APPENDIX: SYSTEM RESOURCES REFERENCE

5.1 BIOS Memory Mapping

<i>Address</i>	<i>Device Description</i>
00000h-9FFFFh	DOS Kernel Area
A0000h,BFFFFh	EGA and VGA Video Buffer (128KB)
C0000h-CFFFFh	EGA/VGA ROM
D0000h-DFFFFh	Adaptor ROM
E0000h-FFFFFFh	System BIOS

5.2 I/O Port Address Map

Each peripheral device in the system is assigned a set of I/O port addresses which also becomes the identity of the device. The following table lists the I/O port addresses used. (**Note:** IDE currently is not supported on the CME-965.)

<i>Address</i>	<i>Device Description</i>
0000h - 0000Fh	DMA Controller
0080h - 009Fh	DMA Controller
00C0h - 00DFh	DMA Controller
0020h, 0021h	Programmable Interrupt Controller
00A0h, 00A1h	Programmable Interrupt Controller
0040h - 0043h	System Timer
0044h - 0047h	System Timer
0060h - 0064h	Keyboard Controller
0070h - 0073h	System CMOS/Real Time Clock
00F0h - 00FFh	Math Co-Processor
01F0h-01F7h	Primary IDE
0274h-0277h	ISAPNP Read Data Port
0279h , 0A79h	ISAPnP Configuration
02F8h-02FFh	COM_2 (If use)
0378h-037Ah	Parallel Port (If use)

03B0h-03BFh	MDA/MGA
03C0h-03CFh	EGA/VGA
03D4h-03D9h	CGA CRT register
03F0h-03F7h	Floppy Diskette
03F6h-03F6h	Primary IDE
03F8h-03FFh	COM_1 (If use)
0400h-041F	South Bridge SMB
04D0h-04D1h	IRQ Edge/level control ports
0500h-053Fh	South Bridge GPIO
0800h-087Fh	ACPI
0A00h-0A07h	PME
0A10h-0A17h	Hardware Monitor
0CF8h	PCI Configuration address
0CFCh	PCI Configuration Data

5.3 Interrupt Request (IRQ) Lines

Peripheral devices use interrupt request lines to notify CPU for the service required. The following table shows the IRQ used by the devices on board.

<i>IRQ Level</i>	<i>Function</i>
IRQ 00	System Timer
IRQ 01	Standard 101/102-Key or Microsoft Natural PS/2 Keyboard
IRQ 02	VGA and Link to Secondary PIC
IRQ 03	Communications Port (COM2)
IRQ 04	Communications Port (COM1)
IRQ 05	PCI Device
IRQ 06	Standard floppy disk controller
IRQ 07	Parallel Port
IRQ 08	System CMOS/real time clock
IRQ 09	Microsoft ACPI-Compliant System
IRQ 10	PCI Device
IRQ 11	PCI Device

IRQ 12	PS/2 Compatible Mouse
IRQ 13	PFY exception
IRQ 14	Primary IDE Channel
IRQ 15	PCI Device

5.4 BIOS Beep Codes

This section contains BIOS codes and troubleshooting information.

5.4.1 Boot Block Beep Codes

<i>Number of Beeps</i>	<i>Description</i>
1	Insert diskette in floppy drive A:
2	'AMIBOOT.ROM' file not found in root directory of diskette in A:
3	Insert next diskette if multiple diskettes are used for Recovery
4	Flash Programming successful
5	Floppy read error
6	Keyboard controller BAT command failed
7	No Flash EPROM detected
8	Floppy controller failure
9	Boot Block BIOS checksum error
10	Flash Erase error
11	Flash Program error
12	'AMIBOOT.ROM' file size error

5.4.2 Post BIOS Beep Codes

<i>Number of Beeps</i>	<i>Description</i>
1	Memory refresh timer error.
2	Parity error in base memory (first 64KB block)
3	Base memory read/write test error
4	Motherboard timer not operational
5	Processor error
6	8042 Gate A20 test error (cannot switch to protected mode)
7	General exception error (processor exception interrupt error)
8	Display memory error (system video adapter)
9	AMIBIOS ROM checksum error
10	CMOS shutdown register read/write error

5.4.3 Troubleshooting Post BIOS Beep Codes

<i>Number of Beeps</i>	<i>Description</i>
1, 2 or 3	Reseat the memory, or replace with known good modules.
4-7, 9-11	<p>Fatal error indicating a serious problem with the system. Consult your system manufacturer. Before declaring the motherboard beyond all hope, eliminate the possibility of interference by a malfunctioning add-in card. Remove all expansion cards except the video adapter.</p> <ul style="list-style-type: none"> • If beep codes are generated when all other expansion cards are absent, consult your system manufacturer's technical support. • If beep codes are not generated when all other expansion cards are absent, one of the add-in cards is causing the malfunction. Insert the cards back into the system one at a time until the problem
8	If the system video adapter is an add-in card, replace or reset the video adapter. If the video adapter is an integrated part of the system board, the board may be faulty.

5.4.4 Bootblock Initialization Code Checkpoints

Checkpoint	Description
Before D0	If boot block debugger is enabled, CPU cache-as-RAM functionality is enabled at this point. Stack will be enabled from this point.
D0	Early Boot Strap Processo (BSP) initialization like microcode update, frequency and other CPU cirtical initialization. Early chipset initialization is done.
D1	Early super I/O initialization is done including RTC and keyboard controller. Serial port is enabled at this point if needed for debugging. NMI is deisabled. Perfrom keyboard controller BAT test. Save power-on CPUID value in scretch CMOS. Go to flat mode with 4GB limit and GA20 enabled.
D2	Verify the boot block checksum. System will hang here if checksum is bad.
D3	Disable CACHE before memory detection. Execute full memory sizing module. If memory sizing module not executed, start memory refresh and do memory sizing in Boot block code. Do additional chipset initialization. Reenabled CACHE. Verify that flat mode is enabled.
D4	Test base 512KB memory. Adjust policies and cache first 8MB. Set stack.
D5	Bootblock code is copied from ROM to lower system memory and control is given to it. BIOS now executes out of RAM. Copies compressed boot block code to memory in right segments. Copies BIOS from ROM to RAM for faster access. Performs main BIOS checksum and updates recovery status accordingly.
D6	Both key sequence and OEM specific method is checked to determine if BIOS recovery is forced. If BIOS recovery is necessary, control flows tocheckpoint E0. Seed <i>Bootblock Recovery Code Checkpoints</i> section of document for more information.
D7	Restore CPUID value back into register. The Bootblock-Runtime interface module is moved to system memory and control is given to it. Determine whether in memory.
D8	The Tuntime module is uncompressed into memory. CPUID information is stored in memory.
D9	Store the Uncompressed pointer for future use in PMM. Copying Main BIOS into memory. Leaves all RAM below 1MB Read-Write including E000 and F000 shadow areas but closing SMRAM.
DA	Restore CPUID value back into register. Give control to BIOS POS (ExecutePOSTKernel). See <i>POST Code Checkpoints</i> section of document for more information.
DC	System is saking from ACPI S3 state.
E1 - E8 EC - EE	OEM memory detection / configuration error. This range is reserved for chipset vendors & system manufacturers. The error associated with this value may be different from one platform to be next.

5.4.5 Bootlock Recovery Code Checkpoints

The Bootblock recovery code gets control when the BIOS determines that a BIOS recovery needs to occur because the user has forced the update or the BIOS checksum is corrupt. The following table describes the type of checkpoints that may occur during the Bootblock recovery portion of the BIOS.

Checkpoint	Description
E0	Initialize the floppy controller in the super I/O. Some interrupt vectors are initialized. DMA controller is initialized. 8259 interrupt controller is initialized. L2 cache is enabled.
E9	Set up floppy controller and data. Attempt to read from floppy.
EA	Enable ATAPI hardware. Attempt to read from ARMD and ATAPI CDROM.
EB	Disable ATAPI hardware. Jump back to checkpoint E9.
EF	Read error occurred on media. Jump back to checkpoint EB.
F0	Search for pre-defined recovery file name in root directory.
F1	Recovery file not found.
F2	Start reading FAT table and analyze FAT to find the clusters occupied by the recovery file.
F3	Start reading the recovery file cluster by cluster.
F5	Disable L1 cache.
FA	Check the validity of the recovery file configuration to the current configuration of the flash part.
FB	Make flash write enabled through chipset and OEM specific method. Detect proper flash part. Verify that the found flash part size equals the recovery file size.
F4	The recovery file size does not equal the found flash part size.
FC	Erase the flash part.
FD	Program the flash part.
FF	The flash has been updated successfully. Make flash write disabled. Disable ATAPI hardware. Restore CPUID value back into register. Give control to F000 ROM at F000:FFF0h.

5.4.6 POST Code Checkpoints

The POST code checkpoints are the largest set of checkpoints during the BIOS pre-boot process. The following table describes the type of checkpoints that may occur during the POST portion of the BIOS.

Checkpoint	Description
03	Disable NMI, Parity, video for EGA, and DMA controllers. Initialize BIOS, POST, Runtime data area. Also initialize BIOS modules on POST entry and GPNV area. Initialized CMOS as mentioned in the Kernel Variable "wCMOSFlags."
04	Check CMOS diagnostic byte to determine if battery power is OK and CMOS checksum is OK. Verify CMOS checksum manually by reading storage area. If the CMOS checksum is bad, update CMOS with power-on default values and clear passwords. Initialize status register A. Initializes data variables that are based on CMOS setup questions. Initializes both the 8259 compatible PICs in the system.
05	Initializes the interrupt controlling hardware (generally PIC) and interrupt vector table.
06	Do R/W test to CH-2 count reg. Initialize CH-0 as system timer. Install the POSTINT1Ch handler. Enable IRQ-0 in PIC for system timer interrupt. Traps INT1Ch vector to "POSTINT1ChHandlerBlock." 07 Fixes CPU POST interface calling pointer.
07	Fixes CPU POST interface calling pointer.
08	Initializes the CPU. The BAT test is being done on KBC. Program the keyboard controller command byte is being done after Auto detection of KB/MS using AMI KB-5.
C0	Early CPU Init Start -- Disable Cache - Init Local APIC
C1	Set up boot strap processor Information
C2	Set up boot strap processor for POST
C5	Enumerate and set up application processors
C6	Re-enable cache for boot strap processor
C7	Early CPU Init Exit
0A	Initializes the 8042 compatible Key Board Controller.
0B	Detects the presence of PS/2 mouse.
0C	Detects the presence of Keyboard in KBC port.
0E	Testing and initialization of different Input Devices. Also, update the Kernel Variables. Traps the INT09h vector, so that the POST INT09h handler gets control for IRQ1. Uncompress all available language, BIOS logo, and Silent logo modules.
13	Early POST initialization of chipset registers.
20	Relocate System Management Interrupt vector for all CPU in the system.
24	Uncompress and initialize any platform specific BIOS modules. GPNV is initialized at this checkpoint.

2A	Initializes different devices through DIM. See DIM Code Checkpoints section of document for more information.
2C	Initializes different devices. Detects and initializes the video adapter installed in the system that have optional ROMs.
2E	Initializes all the output devices.
31	Allocate memory for ADM module and uncompress it. Give control to ADM module for initialization. Initialize language and font modules for ADM. Activate ADM module.
33	Initializes the silent boot module. Set the window for displaying text information.
37	Displaying sign-on message, CPU information, setup key message, and any OEM specific information.
38	Initializes different devices through DIM. See DIM Code Checkpoints section of document for more information. USB controllers are initialized at this point.
39	Initializes DMAC-1 & DMAC-2.
3A	Initialize RTC date/time.
3B	Test for total memory installed in the system. Also, Check for DEL keys to limit memory test. Display total memory in the system.
3C	Mid POST initialization of chipset registers.
40	Detect different devices (Parallel ports, serial ports, and Coprocessor in CPU, ... etc.) successfully installed in the system and update the BDA, EBDA...etc.
52	Updates CMOS memory size from memory found in memory test. Allocates memory for Extended BIOS Data Area from base memory. Programming the memory hole or any kind of implementation that needs an adjustment in system RAM size if needed.
60	Initializes NUM-LOCK status and programs the KBD typematic rate.
75	Initialize Int-13 and prepare for IPL detection.
78	Initializes IPL devices controlled by BIOS and option ROMs.
7C	Generate and write contents of ESCD in NVRam.
84	Log errors encountered during POST.
85	Display errors to the user and gets the user response for error.
87	Execute BIOS setup if needed / requested. Check boot password if installed.
8C	Late POST initialization of chipset registers.
8D	Build ACPI tables (if ACPI is supported)
8E	Program the peripheral parameters. Enable/Disable NMI as selected.
90	Initialization of system management interrupt by invoking all handlers.

A1	Line-up work needed before booting to OS.
A2	Takes care of runtime image preparation for different BIOS modules. Fill the free area in F000h segment with 0FFh. Initializes the Microsoft IRQ Routing Table. Prepares the runtime language module. Disables the system configuration display if needed.
A4	Initialize runtime language module. Display boot option popup menu.
A7	Displays the system configuration screen if enabled. Initialize the CPU's before boot, which includes the programming of the MTRR's.
A9	Wait for user input at config display if needed.
AA	Uninstall POST INT1Ch vector and INT09h vector.
AB	Prepare BBS for Int 19 boot. Init MP tables.
AC	End of POST initialization of chipset registers. De-initializes the ADM module.
B1	Save system context for ACPI. Prepare CPU for OS boot including final MTRR values.
00	Passes control to OS Loader (typically INT19h).

5.4.7 DIM Code Checkpoints

The Device Initialization Manager (DIM) gets control at various times during BIOS POST to initialize different system buses. The following table describes the main checkpoints where the DIM module is accessed.

Checkpoint	Description
2A	<p>Initialize different buses and perform the following functions:</p> <p>Reset, Detect, and Disable (function 0); Static Device Initialization (function); Boot Output Device Initialization (function 2). Function 0 disables all device nodes, PCI devices, and PnP ISA cards. It also assigns PCI bus numbers.</p> <p>Function 1 initializes all static devices that include manual configured onboard peripherals, memory and I/O decode windows in PCI-PCI bridges, and noncompliant PCI devices.</p> <p>Static resources are also reserved. Function 2 searches for and initializes any PnP, PCI, or AGP video devices.</p>
38	<p>Initialize different buses and perform the following functions:</p> <p>Boot Input Device Initialization (function 3); IPL Device Initialization (function 4); General Device Initialization (function 5). Function 3 searches for and configures PCI input devices and detects if system has standard keyboard controller.</p> <p>Function 4 searches for and configures all PnP and PCI boot devices. Function 5 configures all onboard peripherals that are set to an automatic configuration and configures all remaining PnP and PCI devices.</p> <p>While control is in the different functions, additional checkpoints are output to port 80h as a word value to identify the routines under execution. The low byte value indicates the main POST Code Checkpoint. The high byte is divided into two nibbles and contains two fields. The details of the high byte of these checkpoints are as follows:</p> <p>HIGH BYTE XY</p> <p>The upper nibble "X" indicates the function number that is being executed.</p> <p>"X" can be from 0 to 7.</p> <p>0 = func#0, disable all devices on the BUS concerned.</p> <p>2 = func#2, output device initialization on the BUS concerned.</p> <p>3 = func#3, input device initialization on the BUS concerned.</p> <p>4 = func#4, IPL device initialization on the BUS concerned.</p> <p>5 = func#5, general device initialization on the BUS concerned.</p> <p>6 = func#6, error reporting for the BUS concerned.</p> <p>7 = func#7, add-on ROM initialization for all BUSes.</p>

8 = func#8, BBS ROM initialization for all BUSES.

The lower nibble 'Y' indicates the BUS on which the different routines are being executed. 'Y' can be from 0 to 5.

0 = Generic DIM (Device Initialization Manager).

1 = On-board System devices.

2 = ISA devices.

3 = EISA devices.

4 = ISA PnP devices.

5 = PCI devices.

5.4.8 ACPI Runtime Checkpoints

ACPI checkpoints are displayed when an ACPI capable operating system either enters or leaves a sleep state. The following table describes the type of checkpoints that may occur during ACPI sleep or wake events.

<i>Checkpoint</i>	<i>Description</i>
AC	First ASL check point. Indicates the system is running in ACPI mode.
AA	System is running in APIC mode.
01, 02, 03, 04, 05	Entering sleep state S1, S2, S3, S4, or S5.
10, 20, 30, 40, 50	Waking from sleep state S1, S2, S3, S4, or S5.

Note: Checkpoints may differ between different platforms based on system configuration. Checkpoints may change due to vendor requirements, system chipset or option ROMs from add-in PCI devices.